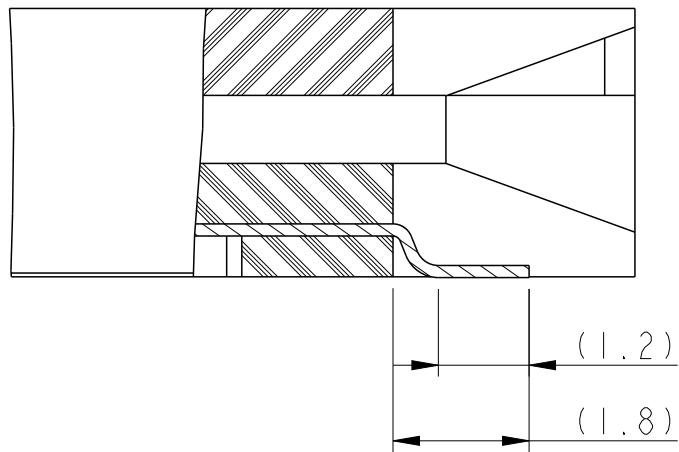
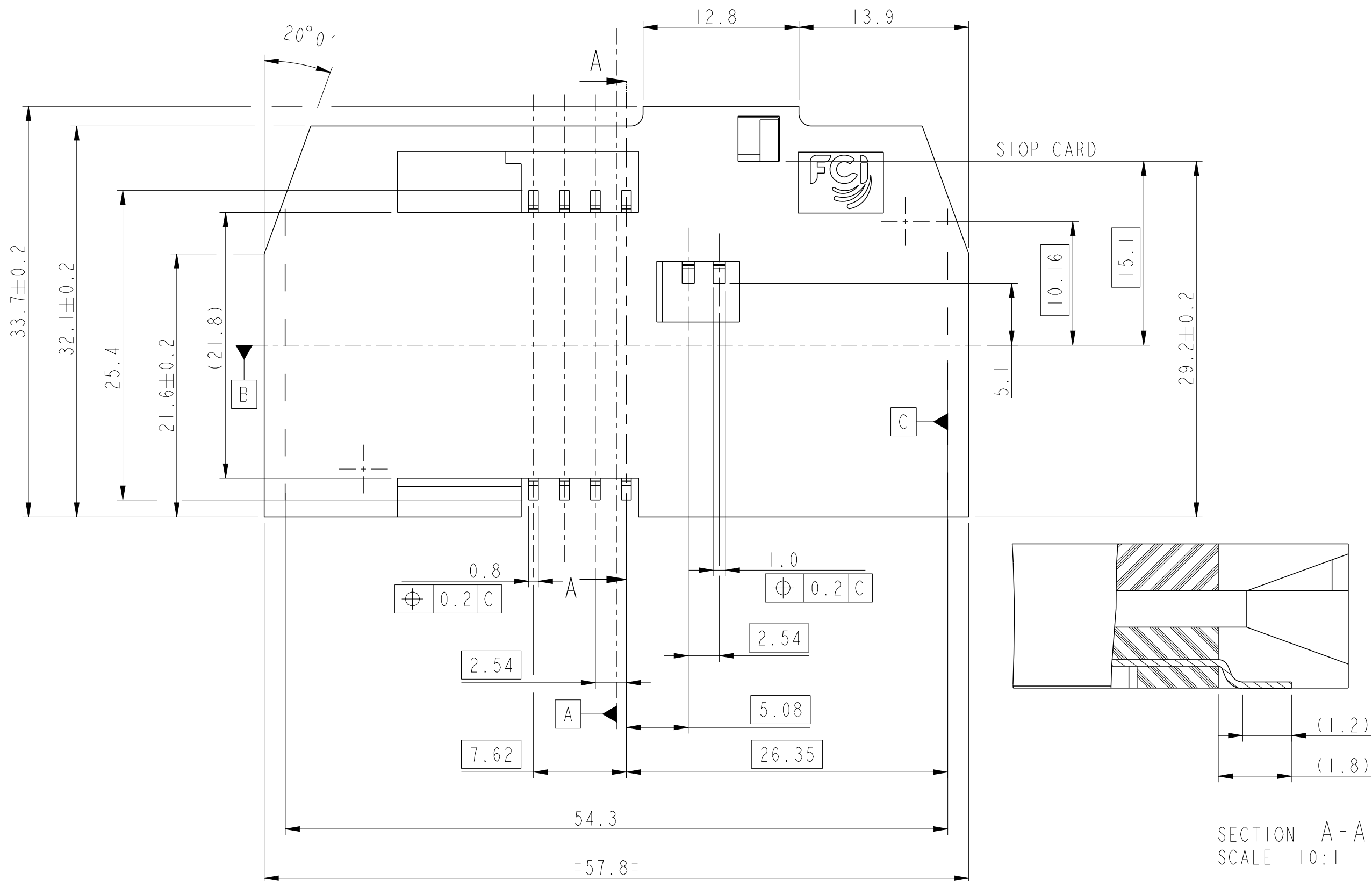
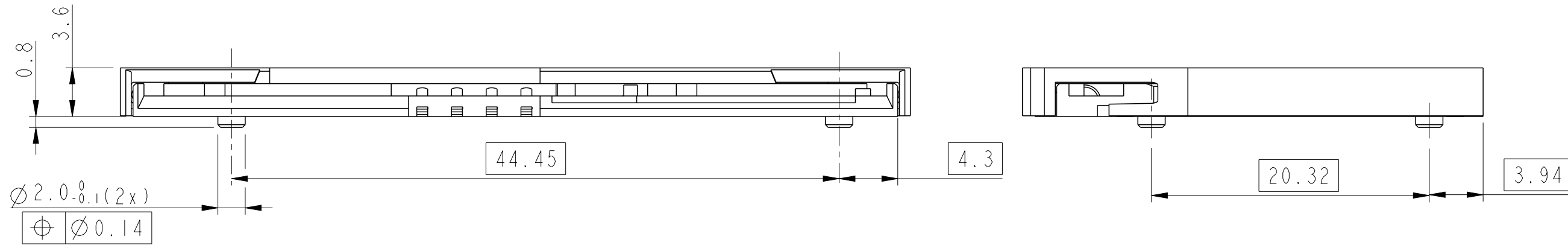
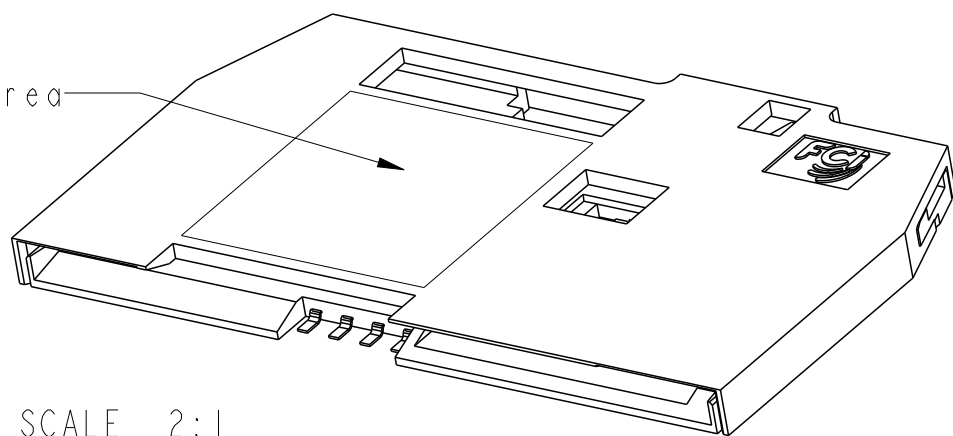


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7712P0225A25LF
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SECTION A-A
SCALE 10:1

Pick and place area



SCALE 2:1

NOTES:

DESCRIPTION

Connector especially designed for SMT technology
EMV compatible and in accordance with ISO 7816-2

MECHANICAL

Contacts force : between 0.2N-0.5N
Durability : 100000 cycles
Insertion force : 10 N max
Extraction force : 1 N min

ELECTRICAL

Insulation resistance : 1000MOhms
Dielectric withstand voltage between card contacts
and detection switch : 1000 Vrms
contact resistance:100 miliohms
Current carrying : min 10 micro A max 1A

SWITCH

Contact closed : contact resistance 100mOhms
Open contact : voltage proof 300Vms

MATERIAL

Contacts : copper alloy
Cover :
Color for LF part : Natural
Plating : Gold / Equivalent PdNi over Nickel on contact area
Solder tails : Sn bare edge allowed
Housing : self extinguishing, Thermoplastic
UL94-V0 rated

ENVIRONMENT

Storage temperature : -40°C, +85°C
Operating temperature : -20°C, +70°C
Packaging : Tray
Compatible reflow soldering process

NOTE: RoHS INFORMATIONS

- The "LF" products meet European Union Directives and other country regulations as described in GS-47-0004 .
- The housing will withstand exposure to 260°C peak temperature for 30 seconds in a convection, infra-red or vapor reflow oven. See Application notes/procedures, if they are available.
- Packaging spec: see GS-14-920

spec ref	SEE NOTES	dr	P-Matthew Nebu	2014/09/27	projection	mm	size	A2	scale	3:1
tolerance std	TOLERANCES UNLESS OTHERWISE SPECIFIED	eng	P-Matthew Nebu	2014/10/08	chr	-	ecn no	ELX-I-18989-1		
ISO 406		appr	K-Paul Bijou	2014/10/08	product family	MOBILE I/O	rel level	Released		
ISO 1101										
surface	✓	linear	0.X	±0.3	FCI	title	CHIP CARD CONNECTOR	dwg no	VJW53666	rev
ISO 1302	angular	0°	±2°	www.fci.com	cat. no.	SEE TABLE	Product - Customer Drw	sheet 1 of 3		L

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PDS: Rev :L

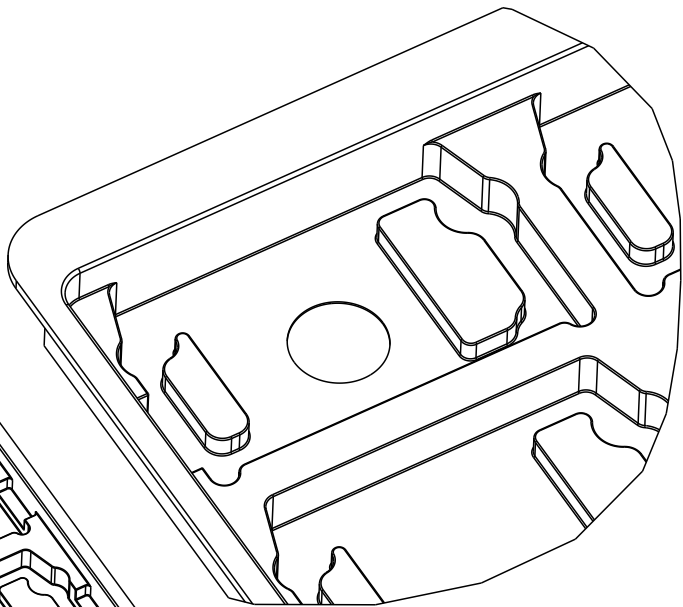
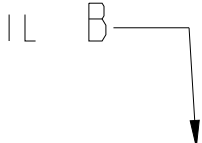
STATUS⁷:Released

Printed: Oct 08, 2014

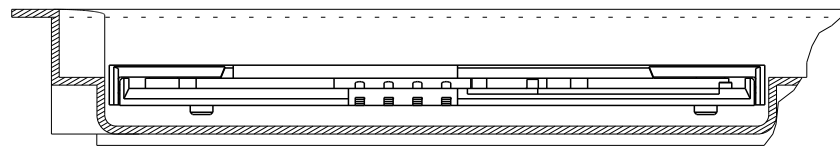
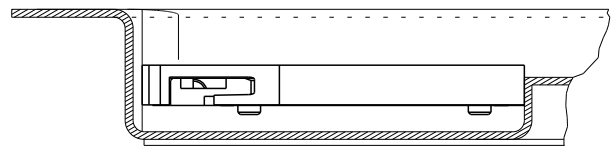
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FOR PICK AND PLACE VERSION

SEE DETAIL B



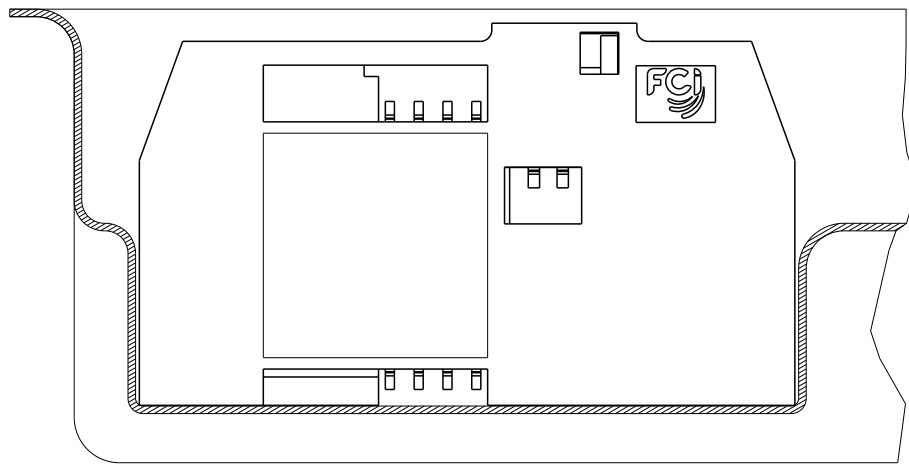
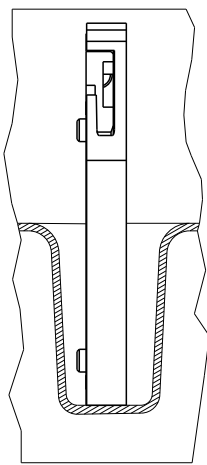
DETAIL B
SCALE 1:1



HORIZONTAL PLACEMENT

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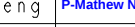
STANDARD VERSION



VERTICAL PLACEMENT

PACKAGING

P / N	Quantity by Tray	Trays Material Detail
7712P0225A25LF	25 Horizontal Placement	Antistatic
7312P0225A13LF	100 Vertical Placement	No Antistatic

spec ref		SEE NOTES		dr		P-Matthew Nebu		2014/09/27		projection		mm		size		A2		scale		3:2			
tolerance std		TOLERANCES UNLESS OTHERWISE SPECIFIED		eng		P-Matthew Nebu		2014/10/08						ecn no		ELX-1-18989-1							
ISO 406				chr		-		-						rel level		Released							
ISO 1101				appr		K-Paul Bijl		2014/10/08						product family		MOBILE I/O							
surface				linear		0.X		±0.3				title		CHIP CARD CONNECTOR		dwg no		VJW53666		rev		L	
				0.XX		±0.1																	
				0.XXX		±0.05																	
ISO 1302		angular		0°		±2°		www.fci.com		cat. no.		SEE TABLE		Product - Customer Drw		sheet 3 of 3							

PDS: Rev :L

STATUS:Released

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